

PATENT ASSIGNMENT COVER SHEET

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 Stylesheet Version v1.2

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SUBMISSION TYPE:	NEW ASSIGNMENT	
NATURE OF CONVEYANCE:	ASSIGNMENT	
CONVEYING PARTY DATA		
	Name	Execution Date
	SHUI-ON LEUNG	08/03/2015
RECEIVING PARTY DATA		
Name:	SINOMAB BIOSCIENCE LIMITED	
Street Address:	508 BIO-INFORMATICS CENTER	
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State/Country:	HONG KONG	
PROPERTY NUMBERS Total: 1		
	Property Type	Number
	Application Number:	15186999
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DATE SIGNED:	06/20/2016	
Total Attachments: 3		
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ASSIGNMENT OF PATENT APPLICATIONS

Whereas I,

Shui-on LEUNG of Hong Kong, NT, CHINA

hereinafter referred to as "Inventor", have invented certain new and useful inventions and discoveries that are the subject of one or more applications for patent entitled "**ANTI-CD22 ANTI-IDIOTYPIC ANTIBODIES AND USES THEREOF**" identified as:

<i>Serial Number</i>	<i>Filing Date</i>
U.S. Provisional Application No. 61/660,327	June 15, 2012
International Patent Application No. PCT/US2013/046053	June 16, 2013
U.S. Utility Patent Application No. 14/407,988	June 16, 2013
European Patent Application No. 13.804606.5	June 16, 2013

and

Whereas, **SINOMAB BIOSCIENCE LIMITED**, a corporation having a business address of Unit 508 Bio-Informatics Center, No. 2 Science Park, West Avenue, Hong Kong Science Park, Shatin, N.T., Hong Kong, CHINA, herein referred to as "ASSIGNEE", is desirous of acquiring the entire right, title and interest in the same;

NOW, THEREFORE, for and in consideration of good and valuable consideration furnished by ASSIGNEE to INVENTOR, receipt and sufficiency of which I hereby acknowledge, I hereby, without reservations:

1. Assign, transfer, and convey to ASSIGNEE, and to its successors and assigns, the entire right, title, and interest in and to said inventions and discoveries throughout the world, including both the above-referenced applications for Letters Patent and any and all other later-filed applications for Letters Patent on said inventions and discoveries in whatsoever countries, including all divisional, renewal, substitute, continuation,

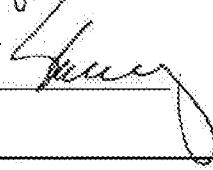
continuation-in-part, and convention applications based in whole, or in part, upon said inventions or discoveries, or upon said applications, and any and all Letters Patents, reissues, and extensions of Letters Patent granted for said inventions and discoveries or upon said applications, and every priority right that is or may be predicated upon, or arise from, said inventions, said discoveries, said applications, and said Letters Patent;

2. Authorize ASSIGNEE to file patent applications in any or all countries on any or all of said inventions and discoveries in my name or in the name of ASSIGNEE or otherwise as ASSIGNEE may deem advisable, under International Conventions or otherwise;
3. Authorize and request that the Commissioner of Patents and Trademarks of the United States of America and the empowered officials of all other governments throughout the world to issue or transfer any and all said Letters Patents to and in the name of ASSIGNEE, its legal representatives, successors or assigns, as the sole owner of the entire right, title and interest in and to said patent(s) and the invention covered thereby as owner of the entire right, title, and interest therein or otherwise as ASSIGNEE may direct;
4. Warrant that I have not knowingly conveyed to others any right in said inventions, discoveries, applications, or patents, or any license to use the same, or to make, use, or sell anything embodying or utilizing any of said inventions or discoveries; and that I have good right to assign the same to ASSIGNEE without encumbrance;
5. Bind my heirs, legal representatives, and assigns, as well as myself, to do, upon ASSIGNEE's request and at ASSIGNEE's expense, but without additional consideration to me or them, all acts reasonably serving to assure that said inventions and discoveries, said patent applications, and said Letters Patents shall be held and enjoyed by ASSIGNEE as fully and entirely as the same could have been held and enjoyed by me, my heirs, legal representatives, and assigns if this Assignment had not been made; and particularly to execute and deliver to ASSIGNEE all lawful application documents including petitions, specifications, and oaths, and all assignments, disclaimers, and lawful affidavits in form and substance as may be requested by ASSIGNEE; and to communicate to ASSIGNEE all facts known to me relating to said inventions and discoveries or the history thereof, and to testify as to the same in any court or proceeding; and to furnish ASSIGNEE any and all documents, photographs, models, samples, and

other physical exhibits in my control or in the control of my heirs, legal representatives,
or assigns which may be useful for establishing the facts of my conceptions, disclosures,
and reduction to practice of said inventions and discoveries.

Executed this 3 day of August, 2015, at Hong Kong (location).

Name of Sole Inventor: Shiu-on LEUNG

Signature: 

Citizen of: Hong Kong SAR (China)
